

G3VM-21BR/ER

MOS FET Relays

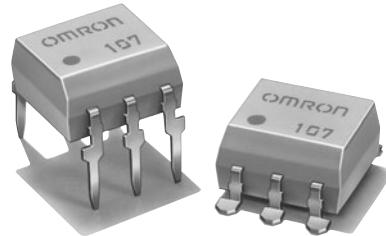
Higher power, 4-A switching with a 20-V

load voltage, DIP package.

Low 20 mΩ ON Resistance.

DIP

G3VM-21BR/ER



NEW

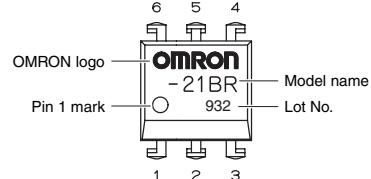
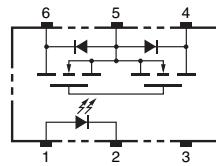
Note: The actual product is marked differently from the image shown here.

RoHS compliant

■ Application Examples

- Communication equipment
- Test & Measurement equipment
- Security equipment
- Factory Automation equipment
- Power circuit

■ Terminal Arrangement/Internal Connections



Note: The actual product is marked differently from the image shown here.

■ List of Models

Package type	Contact form	Terminals	Load voltage (peak value)*	Model	Minimum package quantity	
					Number per stick	Number per tape and reel
DIP6	1a (SPST-NO)	PCB terminals	20 V	G3VM-21BR	50	---
		Surface-mounting terminals		G3VM-21ER		
				G3VM-21ER (TR)		1,500

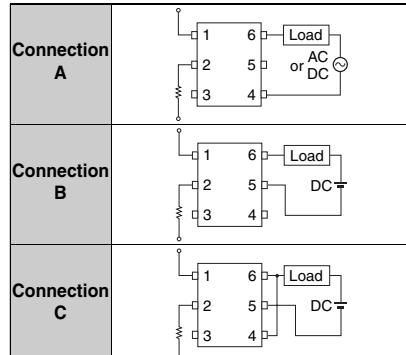
* The AC peak and DC value are given for the load voltage.

■ Absolute Maximum Ratings (Ta = 25°C)

Item		Symbol	Rating	Unit	Measurement conditions
Input	LED forward current	IF	30	mA	
	Repetitive peak LED forward current	IFP	1	A	100 µs pulses, 100 pps
	LED forward current reduction rate	ΔIF/°C	-0.3	mA/°C	Ta ≥ 25°C
	LED reverse voltage	VR	5	V	
Output	Connection temperature	TJ	125	°C	
	Load voltage (AC peak/DC)	V _{OFF}	20	V	
	Continuous load current	Io	4	A	Connection A: AC peak/DC Connection B and C: DC
			4		
			8		
	ON current reduction rate	ΔIo/°C	-40	mA/°C	Ta ≥ 25°C
			-40		
			-80		
	Pulse ON current	I _{OP}	12	A	t = 100 ms, Duty = 1/10
	Connection temperature	T _J	125	°C	
	Dielectric strength between I/O (See note 1.)	V _{i-o}	2500	Vrms	AC for 1 min
Storage temperature	Operating temperature	T _a	-40 to +85	°C	With no icing or condensation
	Storage temperature	T _{stg}	-55 to +125	°C	With no icing or condensation
	Soldering temperature	---	260	°C	10 s

Note: 1. The dielectric strength between the input and output was checked by applying voltage between all pins as a group on the LED side and all pins as a group on the light-receiving side.

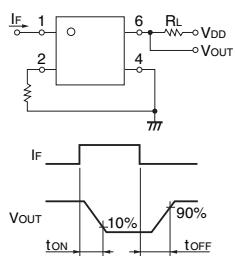
Connection Diagram



■ Electrical Characteristics (Ta = 25°C)

Item		Symbol	Minimum	Typical	Maximum	Unit	Measurement conditions
Input	LED forward voltage	V _F	1.18	1.33	1.48	V	I _F = 10 mA
	Reverse current	I _R	---	---	10	µA	V _R = 5 V
	Capacity between terminals	C _T	---	70	---	pF	V = 0, f = 1 MHz
	Trigger LED forward current	I _{FT}	---	0.5	3	mA	I _O = 1 A
Output	Maximum resistance with output ON	R _{ON}	---	20	50	mΩ	I _F = 5 mA, I _O = 2 A, t < 1s
			---	10	---	mΩ	I _F = 5 mA, I _O = 2 A, t < 1s
			---	5	---	mΩ	I _F = 5 mA, I _O = 4 A, t < 1s
	Current leakage when the relay is open	I _{LEAK}	---	---	1.0	µA	V _{OFF} = 20 V
Storage	Capacity between terminals	C _{OFF}	---	1000	---	pF	V = 0, f = 1 MHz
	Capacity between I/O terminals	C _{i-o}	---	0.8	---	pF	f = 1 MHz, Vs = 0 V
	Insulation resistance between I/O terminals	R _{i-o}	1000	---	---	MΩ	V _{i-o} = 500 VDC, RoH ≤ 60%
	Turn-ON time	t _{ON}	---	2.5	5	ms	I _F = 5 mA, R _L = 200 Ω, V _{DD} = 20 V (See note 2.)
	Turn-OFF time	t _{OFF}	---	0.1	1	ms	

Note: 2. Turn-ON and Turn-OFF Times



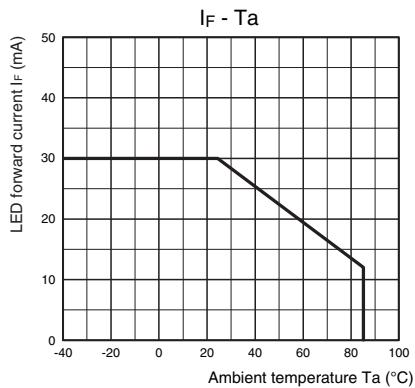
■ Recommended Operating Conditions

Use the G3VM under the following conditions so that the Relay will operate properly.

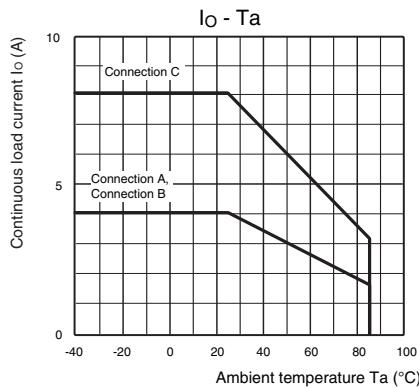
Item	Symbol	Minimum	Typical	Maximum	Unit
Load voltage (AC peak/DC)	V _{DD}	---	---	16	V
Operating LED forward current	I _F	5	10	25	mA
Continuous load current (AC peak/DC)	I _O	---	---	4	A
Operating temperature	T _a	-20	---	65	°C

■ Engineering Data

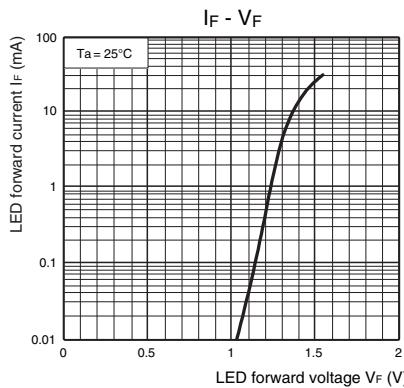
**LED forward current vs.
Ambient temperature**



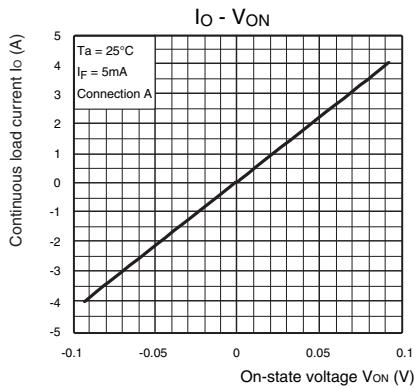
**Continuous load current vs.
Ambient temperature**



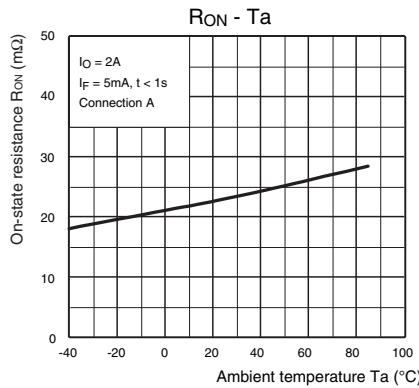
**LED forward current vs.
LED forward voltage**



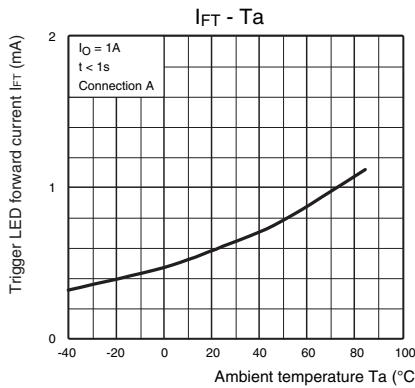
**Continuous load current vs.
On-state voltage**



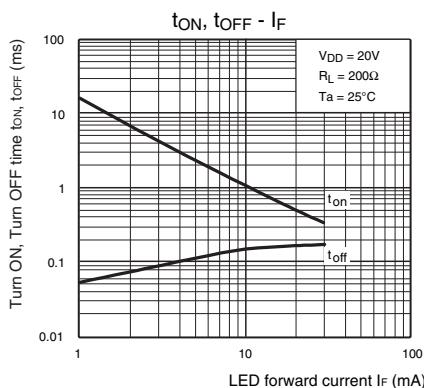
**On-state resistance vs.
Ambient temperature**



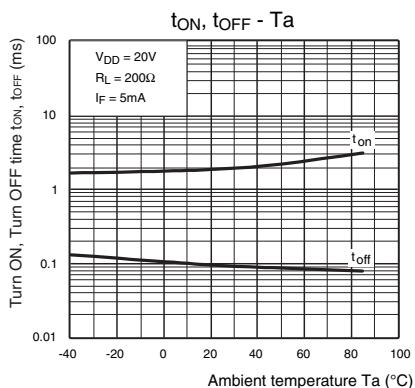
**Trigger LED forward current vs.
Ambient temperature**



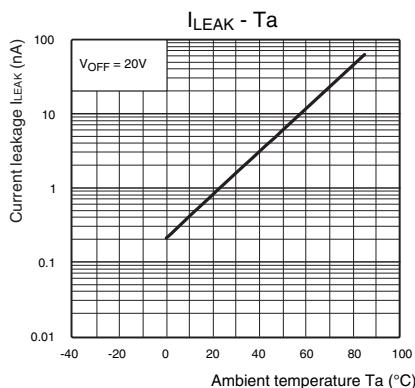
**Turn ON, Turn OFF time vs.
LED forward current**



**Turn ON, Turn OFF time vs.
Ambient temperature**



**Current leakage vs.
Ambient temperature**



■ Safety Precautions

- Refer to "Common Precautions" for all G3VM models.

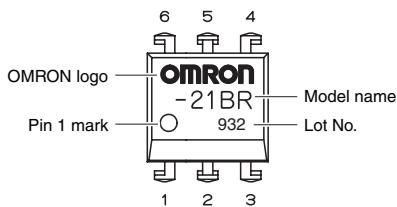
Appearance/Dimensions

DIP6

■ Appearance

DIP (Dual Inline Package)

DIP6



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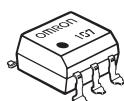
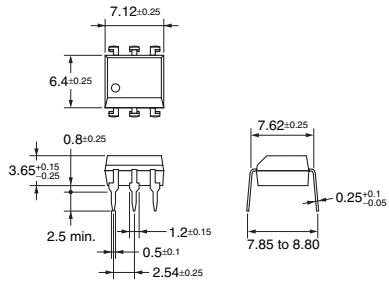
■ Dimensions

(Unit: mm)



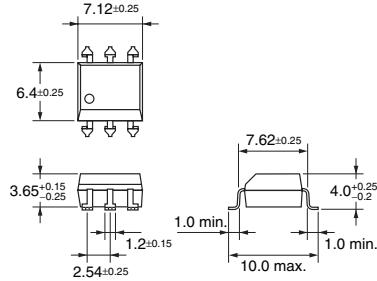
PCB Terminals

Weight: 0.4 g

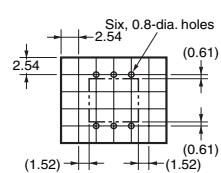


Surface-mounting Terminals

Weight: 0.4 g

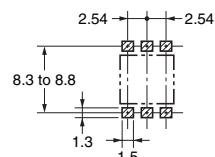


PCB Dimensions (Bottom View)



Actual Mounting Pad Dimensions

(Recommended Value, Top View)



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- Application examples provided in this document are for reference only. In actual applications, confirm equipment functions and safety before using the product.
- Consult your OMRON representative before using the product under conditions which are not described in the manual or applying the product to nuclear control systems, railroad systems, aviation systems, vehicles, combustion systems, medical equipment, amusement machines, safety equipment, and other systems or equipment that may have a serious influence on lives and property if used improperly. Make sure that the ratings and performance characteristics of the product provide a margin of safety for the system or equipment, and be sure to provide the system or equipment with double safety mechanisms.

Note: Do not use this document to operate the Unit.

OMRON Corporation

ELECTRONIC AND MECHANICAL COMPONENTS COMPANY

Contact: www.omron.com/ecb

Cat. No. K136-E1-02
0412(0412)(O)

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